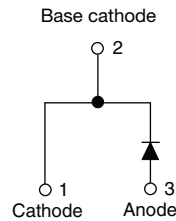


## Hyperfast Rectifier, 30 A FRED Pt® G5


**TO-220AC 2L**


### FEATURES

- Best in class forward voltage drop and switching losses trade off
- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	30 A
$V_R$	600 V
$V_F$ at $I_F$ at 125 °C	1.15 V
$t_{rr}$ (typ.)	25 ns
$T_J$ max.	175 °C
Package	TO-220AC 2L
Circuit configuration	Single

### DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV on-board battery chargers

### MECHANICAL DATA

**Case:** TO-220AC 2L

Molding compound meets UL 94 V-0 flammability rating

**Terminals:** matte tin plated leads, solderable per J-STD-002

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Repetitive peak reverse voltage	$V_{RRM}$		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 113\text{ °C}$ , $D = 0.50$	30	A
Repetitive peak forward current	$I_{FRM}$	$T_C = 113\text{ °C}$ , $D = 0.50$ , $f = 20\text{ kHz}$	60	
Non-repetitive peak surge current	$I_{FSM}$	$T_C = 25\text{ °C}$ , $t_p = 10\text{ ms}$ , sine wave	330	
Operating junction and storage temperature	$T_J$ , $T_{Stg}$		-55 to +175	°C

ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}$ , $V_R$	$I_R = 100\text{ }\mu\text{A}$	600	-	-	V
Forward voltage	$V_F$	$I_F = 30\text{ A}$	-	1.3	1.6	
		$I_F = 30\text{ A}$ , $T_J = 125\text{ °C}$	-	1.15	-	
Reverse leakage current	$I_R$	$V_R = V_R$ rated	-	-	20	$\mu\text{A}$
		$T_J = 125\text{ °C}$ , $V_R = V_R$ rated	-	-	500	
Junction capacitance	$C_T$	$V_R = 200\text{ V}$	-	36	-	pF
Series inductance	$L_S$	Measured to lead 5 mm from package body	-	8	-	nH



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$I_F = 1.0\text{ A}, di_F/dt = 100\text{ A}/\mu\text{s}, V_R = 30\text{ V}$	-	25	-	ns
		$T_J = 25\text{ }^\circ\text{C}$	-	41	-	
		$T_J = 125\text{ }^\circ\text{C}$	-	58	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$	-	19	-	A
		$T_J = 125\text{ }^\circ\text{C}$	-	32	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^\circ\text{C}$	-	419	-	nC
		$T_J = 125\text{ }^\circ\text{C}$	-	1176	-	
Reverse recovery time	$t_{rr}$	$T_J = 25\text{ }^\circ\text{C}$	-	46	-	ns
		$T_J = 125\text{ }^\circ\text{C}$	-	65	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$	-	21	-	A
		$T_J = 125\text{ }^\circ\text{C}$	-	36	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^\circ\text{C}$	-	550	-	nC
		$T_J = 125\text{ }^\circ\text{C}$	-	1560	-	

<b>THERMAL - MECHANICAL SPECIFICATIONS</b>						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance, junction-to-case	$R_{thJC}$		-	-	1.3	$^\circ\text{C}/\text{W}$
Weight			-	2.0	-	g
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Maximum junction and storage temperature range	$T_J, T_{Stg}$		-55	-	175	$^\circ\text{C}$
Marking device		Case style TO-220AC 2L	E5TH3006TH			

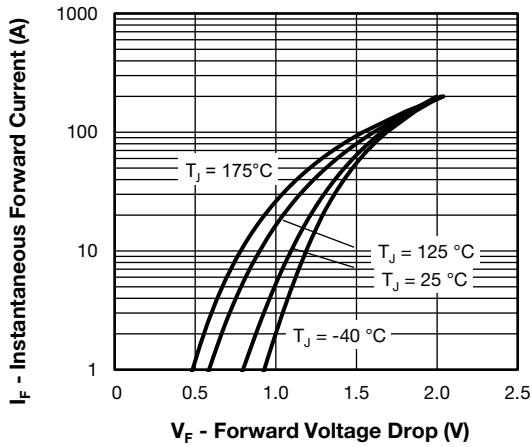


Fig. 1 - Forward Voltage Drop Characteristics, Per Leg

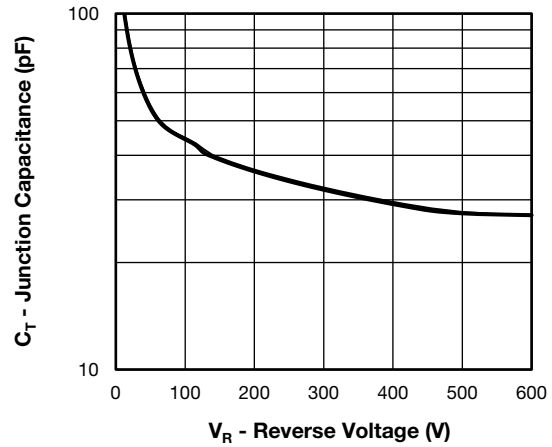


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

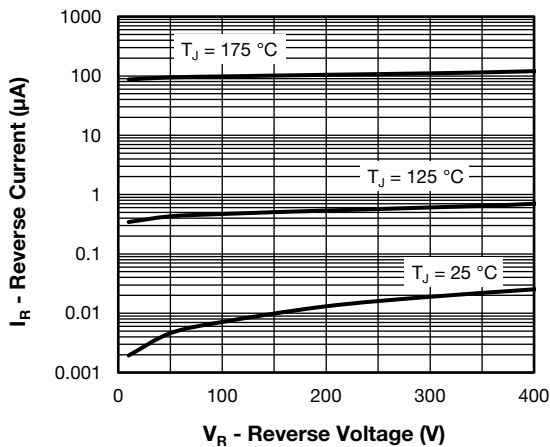


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage, Per Leg

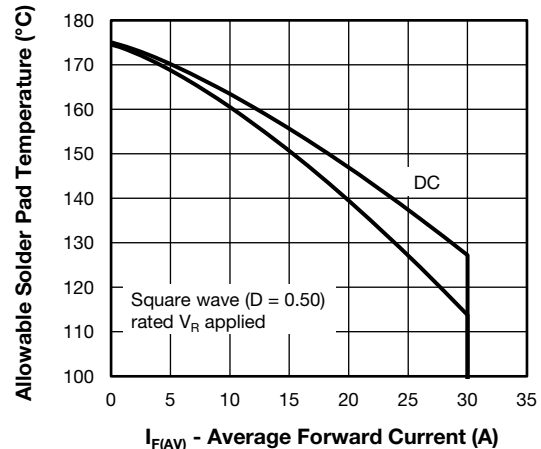


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

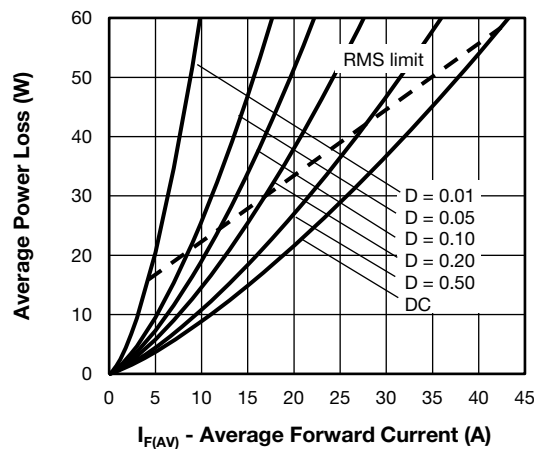


Fig. 5 - Forward Power Loss Characteristics, Per Leg

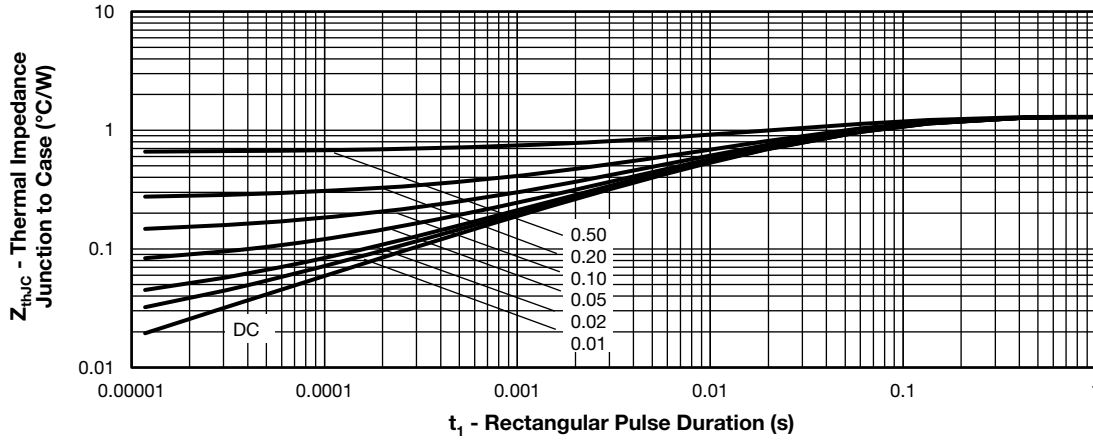


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg

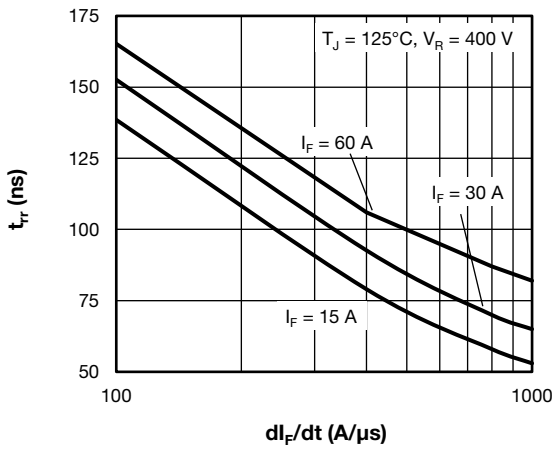


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$ , Per Leg

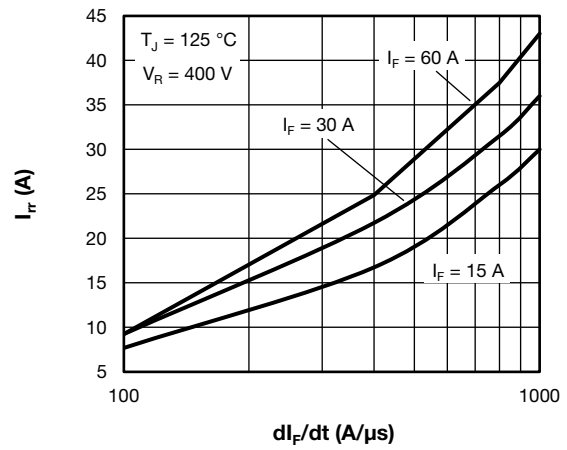


Fig. 9 - Typical Reverse Recovery Current vs.  $dI_F/dt$ , Per Leg

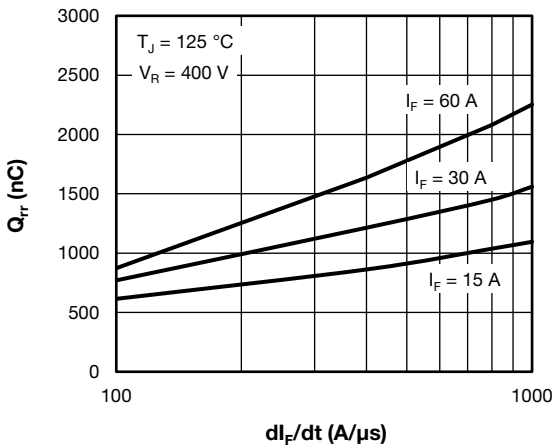


Fig. 8 - Typical Reverse Recovery Charge vs.  $dI_F/dt$ , Per Leg

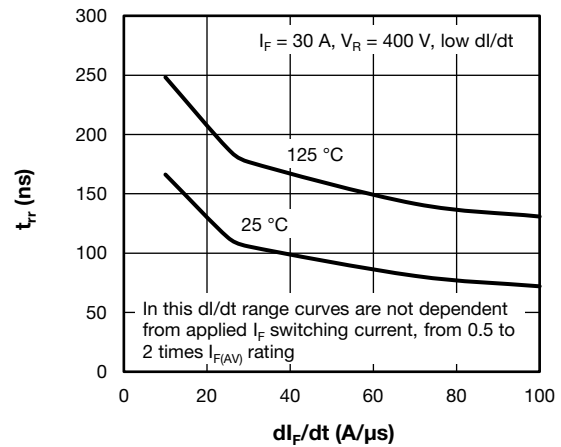


Fig. 10 - Typical Reverse Recovery Time vs.  $dI_F/dt$ , Per Leg

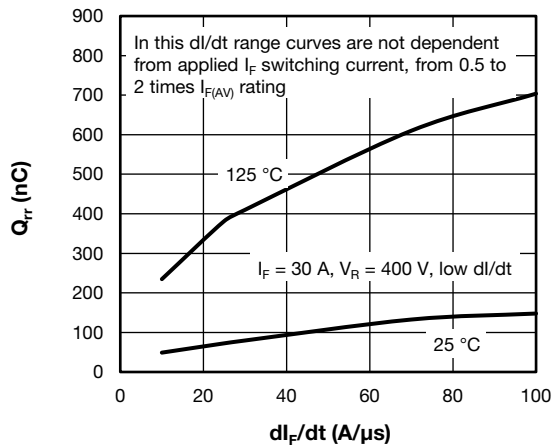


Fig. 11 - Typical Reverse Recovery Charge vs.  $di_F/dt$ , Per Leg

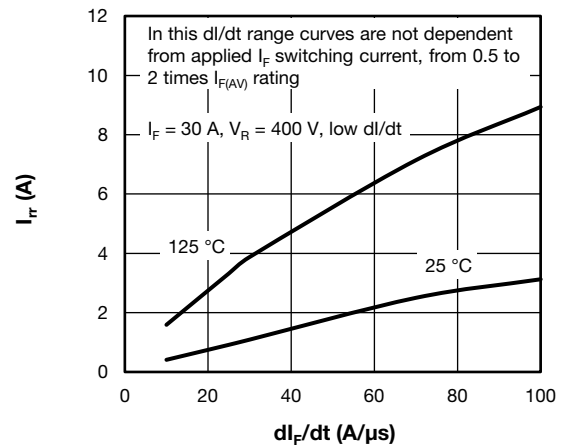


Fig. 12 - Typical Reverse Recovery Current vs.  $di_F/dt$ , Per Leg

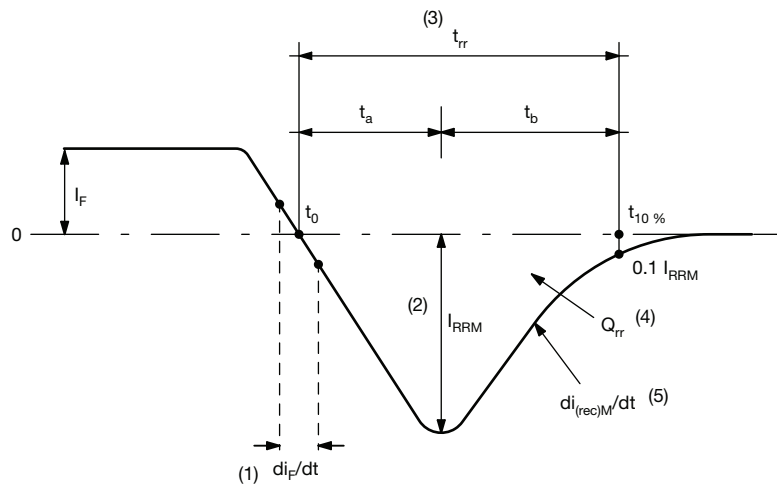


Fig. 13 - Reverse Recovery Waveform and Definitions

**Notes**

- (1)  $di_F/dt$  - rate of change of current through zero crossing
- (2)  $I_{RRM}$  - peak reverse recovery current
- (3)  $t_{rr}$  - reverse recovery time measured from  $t_0$ , crossing point of negative going  $I_F$ , to point  $t_{10\%}$ ,  $0.1 I_{RRM}$
- (4)  $Q_{rr}$  - area under curve defined by  $t_0$  and  $t_{10\%}$

$$Q_{rr} = \int_{t_0}^{t_{10\%}} I(t) dt$$

- (5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$



## ORDERING INFORMATION TABLE

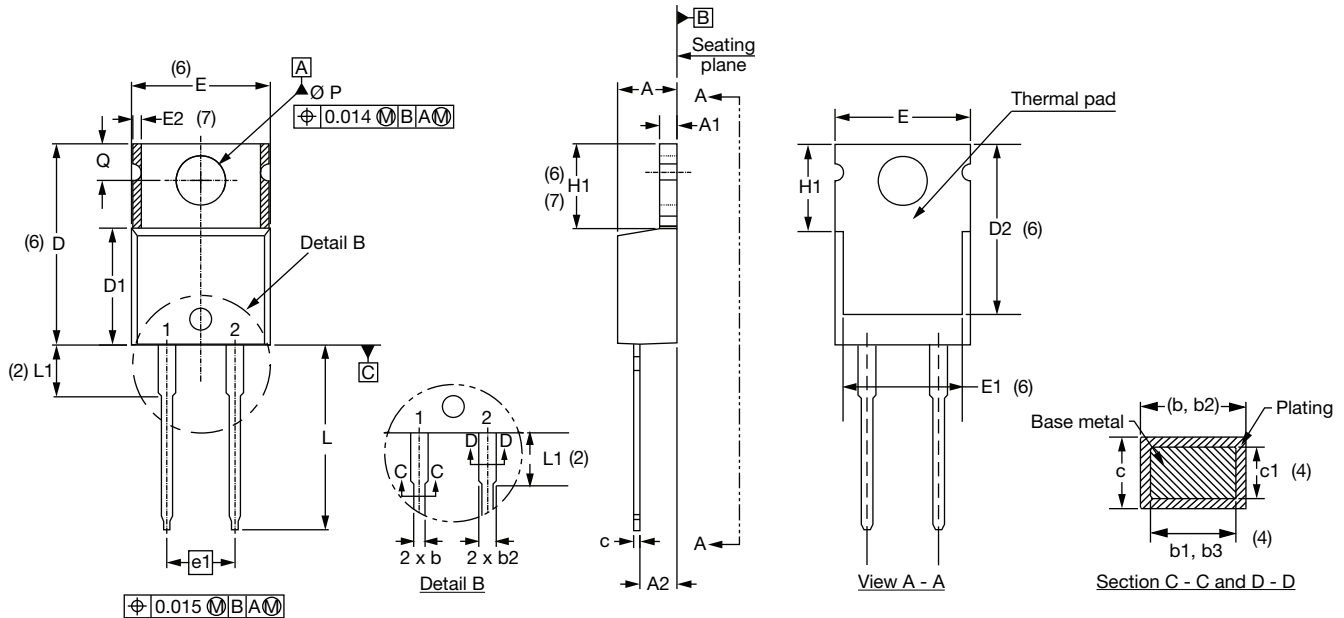
Device code	<b>VS-</b>	<b>E</b>	<b>5</b>	<b>T</b>	<b>H</b>	<b>30</b>	<b>06</b>	<b>T</b>	<b>H</b>	<b>N3</b>
	①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩
<b>1</b>	-	Vishay Semiconductors product								
<b>2</b>	-	E = single diode								
<b>3</b>	-	5 = FRED generation 5								
<b>4</b>	-	Package: T = TO-220AC 2L								
<b>5</b>	-	H = hyperfast recovery								
<b>6</b>	-	Current rating (30 = 30 A)								
<b>7</b>	-	Voltage rating (06 = 600 V)								
<b>8</b>	-	T = true pin TO-220								
<b>9</b>	-	H = AEC-Q101 qualified								
<b>10</b>	-	Environmental digit: N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free								

<b>ORDERING INFORMATION</b> (Example)			
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-E5TH3006THN3	50	1000	Antistatic plastic tube

<b>LINKS TO RELATED DOCUMENTS</b>	
Dimensions	<a href="http://www.vishay.com/doc?96069">www.vishay.com/doc?96069</a>
Part marking information	<a href="http://www.vishay.com/doc?95391">www.vishay.com/doc?95391</a>
SPIICE model	<a href="http://www.vishay.com/doc?96919">www.vishay.com/doc?96919</a>

## TO-220AC 2L

**DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
c	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
E	10.11	10.51	0.398	0.414	3, 6

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
e1	4.88	5.28	0.192	0.208	
H1	5.84	6.86	0.230	0.270	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
Ø P	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	

**Notes**

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC® TO-220, except D2, where JEDEC® minimum is 0.480"



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